





DMC4028SSD

#### **40V COMPLEMENTARY DUAL ENHANCEMENT MODE MOSFET**

## **Product Summary**

Device	V <sub>(BR)DSS</sub>	R <sub>DS(on)</sub> Max	I <sub>D</sub> T <sub>A</sub> = +25°C
Q1	40V	28mΩ @ V <sub>GS</sub> = 10V	7.2A
Qi	400	49mΩ @ V <sub>GS</sub> = 4.5V	5.4A
Q2	-40V	50mΩ @ V <sub>GS</sub> = -10V	-5.2A
Q2	-40 V	79mΩ @ V <sub>GS</sub> = -4.5V	-4.7A

#### **Description**

This MOSFET has been designed to minimize the on-state resistance and yet maintain superior switching performance, making it ideal for high efficiency power management applications.

## **Applications**

- Motor Control
- Backlighting
- DC-DC Converters
- Power Management Functions

#### **Features and Benefits**

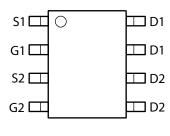
- Low On-Resistance
- · Fast Switching Speed
- Totally Lead-Free & Fully RoHS compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- Qualified to AEC-Q101 Standards for High Reliability

#### **Mechanical Data**

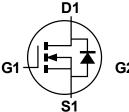
- Case: SO-8
- Case Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals Connections: See diagram below
- Terminals: Finish Matte Tin annealed over Copper lead frame.
   Solderable per MIL-STD-202, Method 208 (23)
- Weight: 0.074 grams (approximate)



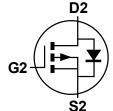




Top View



Q1 N-Channel



Q2 P-Channel

**Equivalent Circuit** 

## Ordering Information (Note 4)

Part Number	Part Number Compliance C		Packaging
DMC4028SSD-13	Standard	SO-8	2500 / Tape & Reel
DMC4028SSDQ-13	Automotive	SO-8	2500 / Tape & Reel

Notes:

- 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant.
- See http://www.diodes.com/quality/lead\_free.html for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. For packaging details, go to our website at http"//www.diodes.com/products/packages.html.

## **Marking Information**





⊃¦¦ = Manufacturer's Marking C4028SD = Product Type Marking Code for DMC4028SSD-13 C4028DQ = Product Type Marking Code for DMC4028SSDQ-13 YYWW = Date Code Marking YY = Year (ex: 09 = 2009) WW = Week (01 - 53)





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### **Maximum Ratings** (@T<sub>A</sub> = +25°C, unless otherwise specified.)

	Symbol	N-Channel - Q1	P-Channel - Q2	Units		
Drain-Source Voltage			$V_{DSS}$	40	-40	V
Gate-Source Voltage (Note 5)		V <sub>GSS</sub>	±20	±20	V	
				7.2	5.2	
Continuous Drain Current	V <sub>GS</sub> = 10V	T <sub>A</sub> = 70°C (Notes 7 & 9)	I <sub>D</sub>	5.5	4.2	Α
		(Notes 6 & 9)		5.4	4	
			1	6.5	4.8	
Pulsed Drain Current V <sub>GS</sub> = 10V (Notes 7 & 9)		(Notes 7 & 9)	I <sub>DM</sub>	27.3	20.4	Α
Continuous Source Current (Body diode)		(Notes 7 & 9)	Is	3.35	3.15	Α
Pulsed Source Current (Body diode)		(Notes 8 & 9)	I <sub>SM</sub>	27.3	20.4	Α

### Thermal Characteristics (@TA = +25°C, unless otherwise specified.)

Characteristic	Symbol	N-Channel - Q1	P-Channel - Q2	Unit	
Davis Discipation	(Notes 6 & 9)		1.2 1		
Power Dissipation Linear Derating Factor	(Notes 6 & 10)	P <sub>D</sub>	1. 14	W mW/°C	
	(Notes 7 & 9)		2. <sup>-</sup> 17		
	(Notes 6 & 9)		10	°C/W	
Thermal Resistance, Junction to Ambient	(Notes 6 & 10)	$R_{\theta JA}$	70		
	(Notes 7 & 9)		58		
Thermal Resistance, Junction to Lead	(Notes 9 & 11)	$R_{\theta JL}$	53	53	
Operating and Storage Temperature Range	T <sub>J,</sub> T <sub>STG</sub>	-55 to	+150	°C	

Notes:

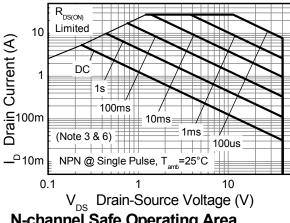
- 5. AEC-Q101  $V_{GS}$  maximum is  $\pm 16V$ .
- 5. ACC-Q101 VQS maximum is ±100.
   6. For a device surface mounted on 25mm x 25mm x 1.6mm FR4 PCB with high coverage of single sided 1oz copper, in still air conditions; the device is measured when operating in a steady-state condition.
   7. Same as note (5), except the device is measured at t ≤ 10 sec.
   8. Same as note (5), except the device is pulsed with D= 0.02 and pulse width 300 μs. The pulse current is limited by the maximum junction temperature.

- 9. For a dual device with one active die.
- 10. For a device with two active die running at equal power.
- 11. Thermal resistance from junction to solder-point (at the end of the drain lead).

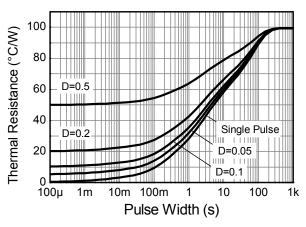
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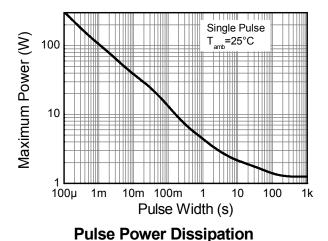
## **Thermal Characteristics**



**N-channel Safe Operating Area** 

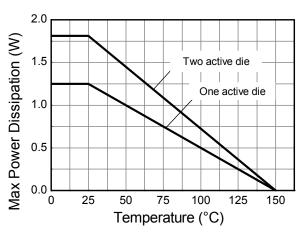


**Transient Thermal Impedance** 



R<sub>DS(ON)</sub> Drain Current (A) Limited 10 100ms (Note 3 & 6) <del>\_</del> 10m PNP @ Single Pulse, T<sub>amb</sub>=25°C 0.1 10

-V<sub>DS</sub> Drain-Source Voltage (V) P-channel Safe Operating Area



**Derating Curve** 



# Electrical Characteristics – Q1 N-Channel (@T<sub>A</sub> = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition	
OFF CHARACTERISTICS							
Drain-Source Breakdown Voltage	BV <sub>DSS</sub>	40	_	_	V	$I_D = 250 \mu A, V_{GS} =$	= 0V
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	_	_	0.5	μA	V <sub>DS</sub> = 40V, V <sub>GS</sub> =	: 0V
Gate-Source Leakage	I <sub>GSS</sub>	_	_	±100	nA	$V_{GS}$ = ±20V, $V_{DS}$	= 0V
ON CHARACTERISTICS						_	
Gate Threshold Voltage	V <sub>GS(th)</sub>	1.0	_	3.0	<b>V</b>	$I_D = 250 \mu A, V_{DS} =$	= V <sub>GS</sub>
Static Drain-Source On-Resistance (Note 12)	В		0.018	0.028	Ω	V <sub>GS</sub> = 10V, I <sub>D</sub> = 6	6A
Static Dialii-Source Oil-Resistance (Note 12)	R <sub>DS (ON)</sub>	_	0.033	0.049	22	$V_{GS} = 4.5V, I_D = 8$	5A
Forward Transconductance (Notes 12 & 13)	9 <sub>fs</sub>	_	22.8	_	S	$V_{DS} = 15V, I_{D} = 6$	A
Diode Forward Voltage (Note 12)	V <sub>SD</sub>	_	0.845	1.1	V	I <sub>S</sub> = 6A, V <sub>GS</sub> = 0V	
Reverse recovery time (Note 13)	t <sub>rr</sub>		135	_	ns	-I <sub>S</sub> = 6A, di/dt = 100A/μs	
Reverse recovery charge (Note 13)	Q <sub>rr</sub>	_	799	_	nC		
DYNAMIC CHARACTERISTICS (Note 13)							
Input Capacitance	C <sub>iss</sub>	_	604	_	pF	.,	0) /
Output Capacitance	Coss	_	106	_	pF	V <sub>DS</sub> = 20V, V <sub>GS</sub> = -f = 1MHz	: 0V
Reverse Transfer Capacitance	C <sub>rss</sub>	_	59.6	_	pF	1 - 11/11/12	
Total Gate Charge (Note 14)	Qg	_	6.5	_	nC	V <sub>GS</sub> = 4.5V	
Total Gate Charge (Note 14)	$Q_g$	_	12.9	_	nC		V <sub>DS</sub> = 20V
Gate-Source Charge (Note 14)	Qgs	_	2.3	_	nC	V <sub>GS</sub> = 10V	
Gate-Drain Charge (Note 14)	Q <sub>gd</sub>	_	3.6	_	nC		
Turn-On Delay Time (Note 14)	t <sub>D(on)</sub>	_	4.2	_	ns		
Turn-On Rise Time (Note 14)	t <sub>r</sub>	_	12.4	_	ns	$V_{DD}$ = 20V, $V_{GS}$ = 10V $I_{D}$ = 6A, $R_{G} \approx 6.0\Omega$	
Turn-Off Delay Time (Note 14)	t <sub>D(off)</sub>	_	13.8	_	ns		
Turn-Off Fall Time (Note 14)	t <sub>f</sub>		10.7	_	ns		

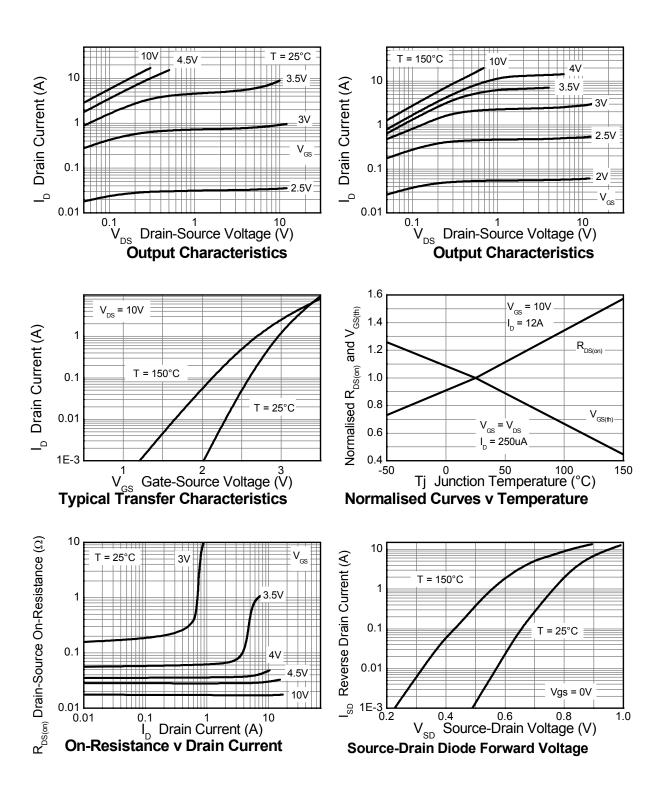
Notes:

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<sup>12.</sup> Measured under pulsed conditions. Pulse width  $\leq 300 \mu s$ ; duty cycle  $\leq 2\%$  13. For design aid only, not subject to production testing. 14. Switching characteristics are independent of operating junction temperatures.

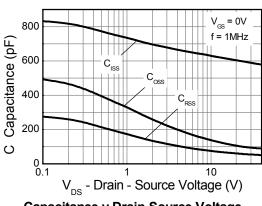


## Typical Characteristics - Q1 N-Channel

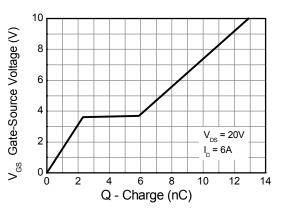




# Typical Characteristics - Q1 N-Channel - (cont.)

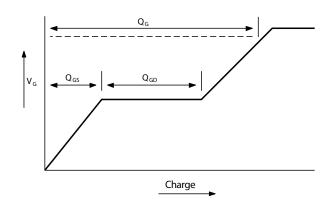


Capacitance v Drain-Source Voltage

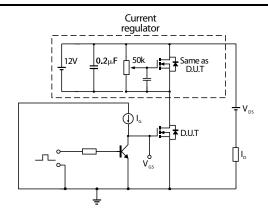


Gate-Source Voltage v Gate Charge

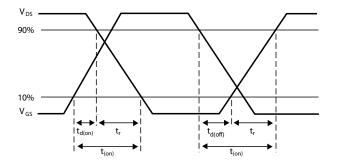
### Test Circuits - Q1 N-Channel



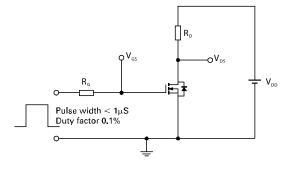
Basic gate charge waveform



Gate charge test circuit



Switching time waveforms



Switching time test circuit





# Electrical Characteristics – Q2 P-Channel (@T<sub>A</sub> = +25°C, unless otherwise specified.)

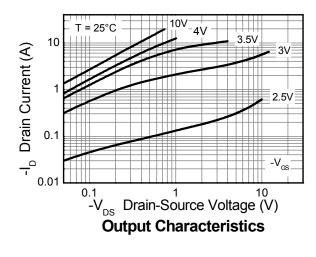
Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition	
OFF CHARACTERISTICS		•		•			
Drain-Source Breakdown Voltage	BV <sub>DSS</sub>	-40	_	_	V	I <sub>D</sub> = -250 μA, V <sub>GS</sub> = 0V	
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	_	_	-0.5	μA	$V_{DS}$ = -40V, $V_{GS}$	= 0V
Gate-Source Leakage	I <sub>GSS</sub>	_	_	±100	nA	$V_{GS} = \pm 20V, V_{DS}$	s = 0V
ON CHARACTERISTICS	•			•		1	
Gate Threshold Voltage	V <sub>GS(th)</sub>	-1.0	_	-3.0	V	I <sub>D</sub> = -250 μA, V <sub>DS</sub> = V <sub>GS</sub>	
Chatia Dania Course On Designation of (New 12)	-		0.039	0.050	0	V <sub>GS</sub> = -10V, I <sub>D</sub> =	-6A
Static Drain-Source On-Resistance (Note 12)	R <sub>DS(ON)</sub>	_	0.060	0.079	Ω	$V_{GS} = -4.5V, I_{D} =$	= -5A
Forward Transconductance (Notes 12 & 13)	9 <sub>fs</sub>	_	16.6	_	S	V <sub>DS</sub> = -15V, I <sub>D</sub> =	-6A
Diode Forward Voltage (Note 13)	$V_{SD}$	_	-0.865	-1.1	V	I <sub>S</sub> = -6A, V <sub>GS</sub> = 0V	
Reverse Recovery Time (Note 13)	t <sub>rr</sub>	_	138	_	ns	I <sub>S</sub> = -6A, di/dt = 100A/μs	
Reverse Recovery Charge (Note 13)	Q <sub>rr</sub>	_	841	_	nC		
DYNAMIC CHARACTERISTICS (Note 13)		•		•			
Input Capacitance	C <sub>iss</sub>	_	674	_	pF	V <sub>DS</sub> = -20V, V <sub>GS</sub> = 0V f = 1MHz	
Output Capacitance	Coss	_	115	_	pF		
Reverse Transfer Capacitance	C <sub>rss</sub>	_	67.7	_	pF	1 - 11/11/12	
Total Gate Charge (Note 14)	Qg	_	7.0	_	nC	V <sub>GS</sub> = -4.5V	
Total Gate Charge (Note 14)	Qg	_	14	_	nC		V <sub>DS</sub> = -20V
Gate-Source Charge (Note 14)	Qgs	_	2.2	_	nC	V <sub>GS</sub> = -10V	$I_D = -6A$
Gate-Drain Charge (Note 14)	Q <sub>gd</sub>	_	3.7	_	nC	1	
Turn-On Delay Time (Note 14)	t <sub>D(on)</sub>	_	2.3	_	ns		
Turn-On Rise Time (Note 14)	t <sub>r</sub>	_	14.1	_	ns	V <sub>DD</sub> = -20V, V <sub>GS</sub> = -10V	
Turn-Off Delay Time (Note 14)	t <sub>D(off)</sub>	_	25.1	_	ns	$I_D = -6A, R_G \cong 6.0\Omega$	
Turn-Off Fall Time (Note 14)	t <sub>f</sub>	_	14.3	_	ns		

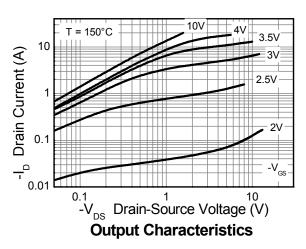
Notes:

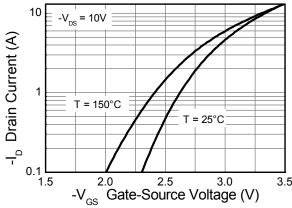
<sup>12.</sup> Measured under pulsed conditions. Pulse width  $\leq$  300µs; duty cycle  $\leq$  2% 13. For design aid only, not subject to production testing. 14. Switching characteristics are independent of operating junction temperatures.

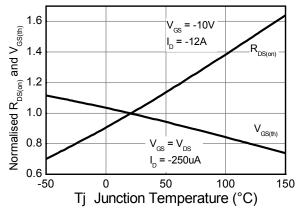


# Typical Characteristics - Q2 P-Channel



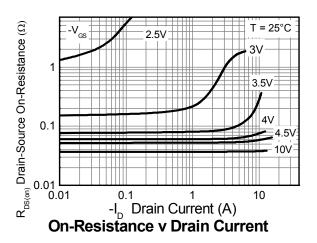


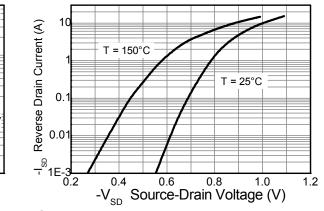




**Typical Transfer Characteristics** 

Normalised Curves v Temperature

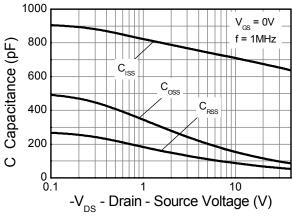




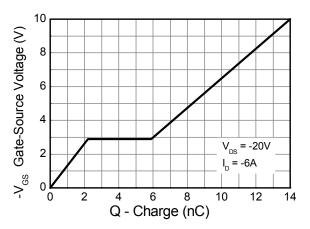
Source-Drain Diode Forward Voltage



## Typical Characteristics – Q2 P-Channel – (cont.)

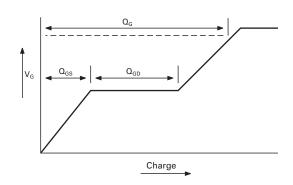


Capacitance v Drain-Source Voltage

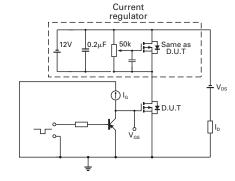


**Gate-Source Voltage v Gate Charge** 

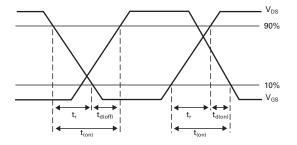
### Test Circuits - Q2 P-Channel



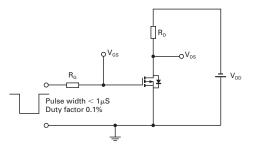
Basic gate charge waveform



Gate charge test circuit



Switching time waveforms

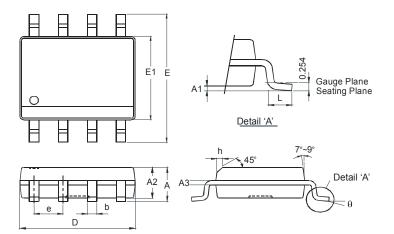


Switching time test circuit



## **Package Outline Dimensions**

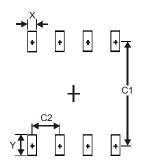
Please see AP02002 at http://www.diodes.com/datasheets/ap02002.pdf for latest version.



SO-8					
Dim	Min	Max			
Α	-	1.75			
A1	0.10	0.20			
A2	1.30	1.50			
A3	0.15	0.25			
b	0.3	0.5			
D	4.85	4.95			
Е	5.90	6.10			
E1	3.85	3.95			
е	1.27	Тур			
h	-	0.35			
L	0.62	0.82			
θ	0°	8°			
All Dimensions in mm					

# **Suggested Pad Layout**

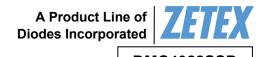
Please see AP02001 at http://www.diodes.com/datasheets/ap02001.pdf for the latest version.



Dimensions	Value (in mm)
Х	0.60
Υ	1.55
C1	5.4
C2	1.27

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DMC4028SSD

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